MFBA2V1608

Automotive multilayer chip ferrite bead



Product features

- · AEC-Q200 qualified
- Multilayer monolithic construction yields high reliability
- 0603 (1608 metric) surface mount package
- Ultra-low direct current resistance (DCR)
- Impedance range: 30 ohms to 600 ohms
- Moisture sensitivity level (MSL): 1

Applications

- Body electronics (keyless entry, ECU, antennas)
- Advanced driver assistance systems (ADAS)
- Infotainment and cluster electronics
- Safety electronics systems
- WLAN, WiFi, Bluetooth
- Portable medical devices
- Inventory management equipment
- Displays/monitors
- IoT, remote monitoring
- Testing equipment
- Automation equipment
- Sensors

Environmental compliance and general specifications

- Operating temperature range: -55 °C to +150 °C (ambient plus self-temperature rise)
- Storage temperature (component): -55 °C to +150 °C
- Solder reflow temperature: J-STD-020 (latest revision) compliant







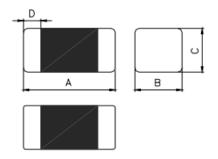


Product specifications

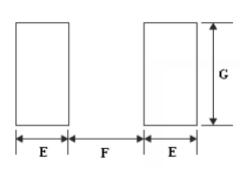
Part number²	Impedance (Ω) 100 MHz, ±25%, @ +25°C	DCR (Ω) maximum @ +25 °C	Rated current ¹ (mA) maximum
MFBA2V1608-300-R	30	0.04	3000
MFBA2V1608-800-R	80	0.04	3000
MFBA2V1608-121-R	120	0.10	2000
MFBA2V1608-151-R	150	0.10	2000
MFBA2V1608-221-R	220	0.10	2000
MFBA2V1608-301-R	300	0.20	1000
MFBA2V1608-471-R	470	0.20	1000
MFBA2V1608-601-R	600	0.20	1000

^{1.} Rated current: Current rating for an approximate self-temperature rise of 40 °C or less.

Mechanical parameters (mm)



Recommended pad layout



Schematic



Part number	Α	В	С	D	E (ref.)	F (ref.)	G (ref.)
MFBA2V1608-***-R	1.6 ±0.15	0.80 ±0.15	0.80 ±0.15	0.30 ±0.20	0.80	0.85	0.95

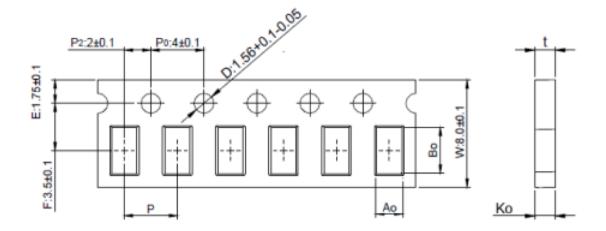
Part marking: No marking
All soldering surfaces to be coplanar within 0.1 millimeters
Tolerances are ±0.1 millimeters unless stated otherwise
Pad layout dimensions are reference only
Traces or vias underneath the inductor is not recommended

^{2.} Part number definition: MFBA2V1608-xxx-R MFBA2V1608 = Product code and size $xxx = \text{Impedance value in } \Omega, \text{ last character equals number of zeros} - \text{R suffix} = \text{RoHS compliant}$

Packaging information (mm)

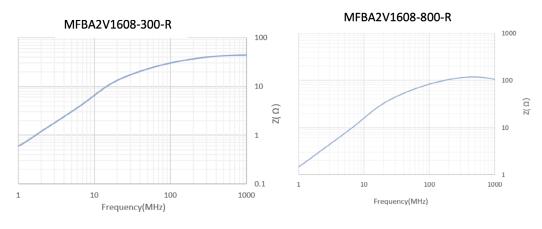
Drawing not to scale

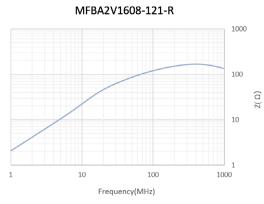
Supplied in tape and reel packaging, 4000 parts per 7" diameter reel (EIA-481 compliant)

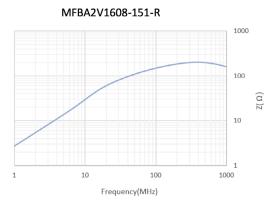


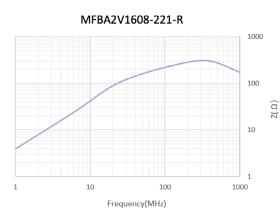
Во	1.80 ± 0.05
Ao	0.96 + 0.05/-0.03
Ко	0.95 ± 0.05
P	4.0 ± 0.10
t	0.95 ± 0.05

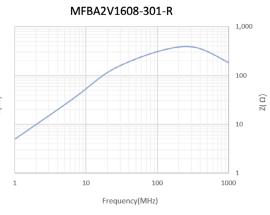
Impedance vs frequency

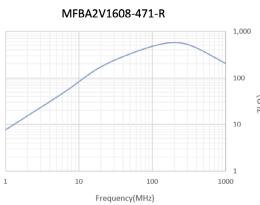














Solder reflow profile

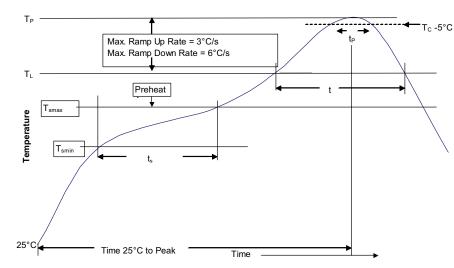


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{Smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate T_L to T_p	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T_L) Time (t_L) maintained above T_L	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (T _P)*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature (T_c)	20 seconds*	30 seconds*
Ramp-down rate (Tp to TL)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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